



ZXMN15A27K

150V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

$V_{(BR)DSS}$	$R_{DS(on)}$	I_D $T_A = 25^\circ C$
150V	650m Ω @ $V_{GS} = 10V$	2.6A

Description and Applications

This MOSFET features low on-state resistance, fast switching and high avalanche withstand capability, making it ideal for high efficiency power management applications.

- SLIC line drivers for VoIP applications
- Transformer Driving Switch
- Power management functions
- Motor control
- Uninterrupted power supply

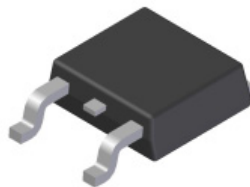
Features and Benefits

- 100% Unclamped Inductive Switch (UIS) test in production
- High avalanche energy pulse withstand capability
- Low input capacitance
- Low on-resistance
- Fast switching speed
- "Green" component and RoHS Compliant (Note 1)
- Qualified to AEC-Q101 Standards for High Reliability

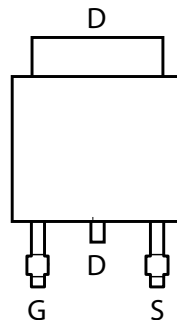
Mechanical Data

- Case: TO252-3L
- Case Material: Molded Plastic "Green" Molding Compound, UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Matte Tin Finish annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.33 grams (approximate)

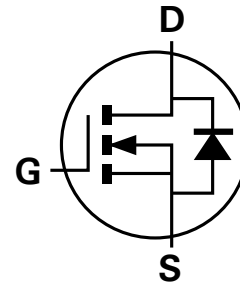
TO252-3L



Top View



Pin Out – Top View



Equivalent Circuit

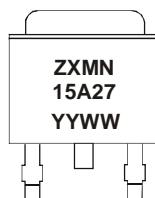
www.DataSheet4U.com

Ordering Information (Note 1)

Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
ZXMN15A27KTC	See Below	13	16	2,500

Notes: 1. Diodes, Inc. defines "Green" products as those which are Eu RoHS compliant and contain no halogens or antimony compounds; further information about Diodes Inc.'s "Green" Policy can be found on our website. For packaging details, go to our website.

Marking Information



ZXMN = Product Type Marking Code, Line 1
15A27 = Product Type Marking Code, Line 2
YYWW = Date Code Marking
YY = Last two digits of year (ex: 09 = 2009)
WW = Week (01-52)

ZXMN15A27K

Maximum Ratings @T_A = 25°C unless otherwise specified

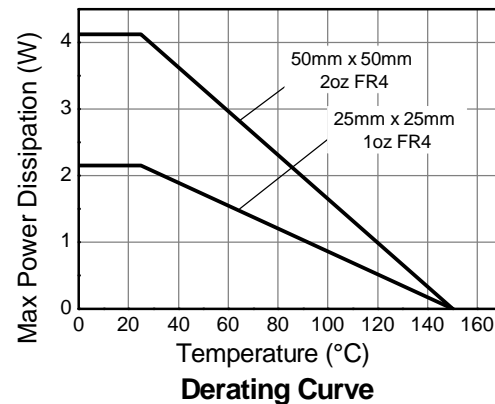
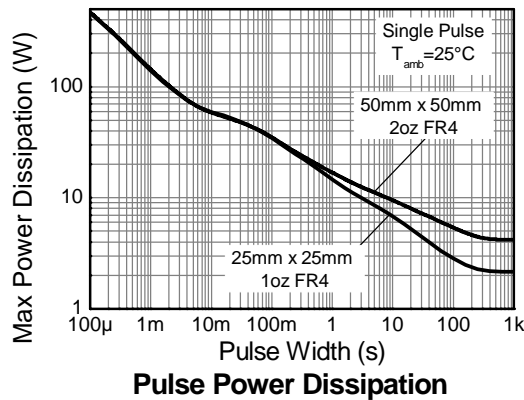
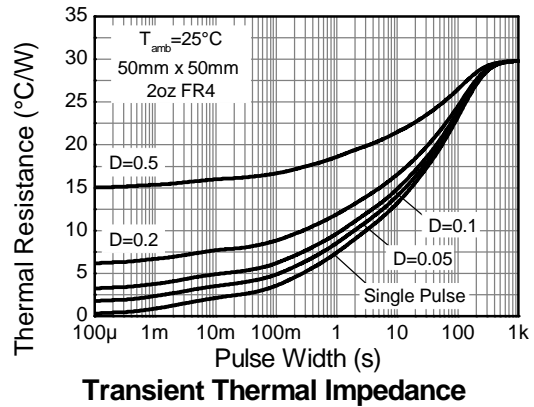
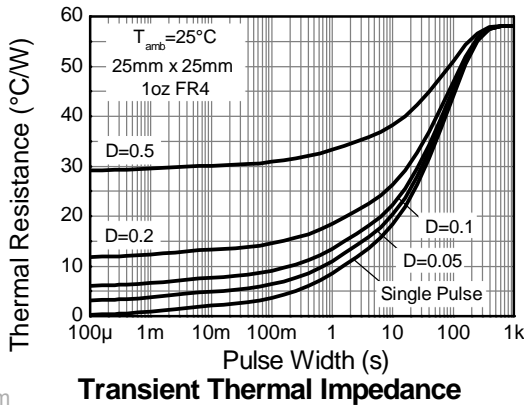
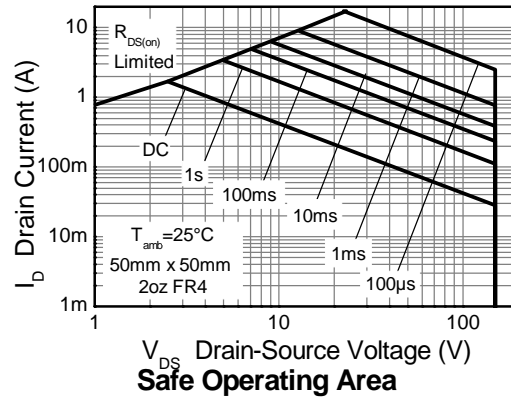
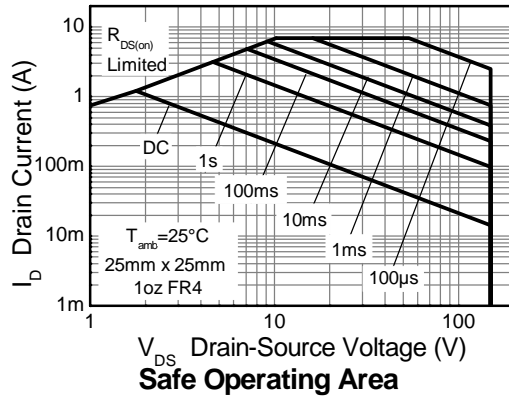
Characteristic		Symbol	Value	Unit
Drain-Source voltage		V _{DSS}	150	V
Gate-Source voltage		V _{GS}	±25	V
Single Pulsed Avalanche Energy	(Note 7)	E _{AS}	55	mJ
Single Pulsed Avalanche Energy	(Note 7)	I _{AS}	4.3	A
Repetitive Avalanche Energy	(Note 4)	E _{AR}	3.0	mJ
Repetitive Avalanche Current	(Note 4)	I _{AR}	4.3	A
Continuous Drain current	V _{GS} = 10V T _A = 70°C (Note 3)	I _D	2.55	A
			2.0	
			1.7	
Pulsed Drain current	V _{GS} = 10V (Note 4)	I _{DM}	17.2	A
Continuous Source current (Body diode)		I _S	5.2	A
Pulsed Source current (Body diode)		I _{SM}	17.2	A

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Power dissipation Linear derating factor	(Note 2)	P _D	4.2	W mW/°C
			33.6	
	(Note 3)		9.5	
			76.0	
	(Note 6)		2.2	
			17.2	
Thermal Resistance, Junction to Ambient	(Note 2)	R _{θJA}	30.2	°C/W
	(Note 3)		13.1	
	(Note 6)		58.1	
Thermal Resistance, Junction to Lead	(Note 5)	R _{θJL}	2.06	°C/W
Operating and storage temperature range		T _J , T _{STG}	-55 to 150	°C

- Notes:
2. For a device surface mounted on 50mm x 50mm x 1.6mm FR4 PCB with high coverage of single sided 2oz copper, in still air conditions. The device is measured when operating in a steady-state condition.
 3. Same as note 2, except the device is measured at t ≤ 10 sec.
 4. Same as note 2, except the device is operating in a repetitive state with pulse width and duty cycle limited by maximum junction temperature.
 5. Thermal resistance from junction to solder-point at the end of the drain lead.
 6. For a device surface mounted on 25mm x 25mm x 1.6mm FR4 PCB with high coverage single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition..
 7. UIS in production with L = 5.95mH, I_{AS} = 4.3A, R_G = 25Ω, V_{DD} = 100V, starting T_J = 25°C.

Thermal Characteristics



ZXMN15A27K

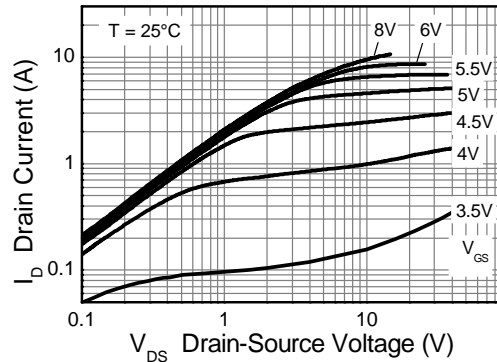
Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV _{DSS}	150	—	—	V	I _D = 250μA, V _{GS} = 0V
Zero Gate Voltage Drain Current	I _{DSS}	—	—	500	nA	V _{DS} = 150V, V _{GS} = 0V
Gate-Source Leakage	I _{GSS}	—	—	±100	nA	V _{GS} = ±25V, V _{DS} = 0V
ON CHARACTERISTICS						
Gate Threshold Voltage	V _{GS(th)}	2	2.7	4	V	I _D = 250μA, V _{DS} = V _{GS}
Static Drain-Source On-Resistance (Note 8)	R _{DS (ON)}	—	0.500	0.650	Ω	V _{GS} = 10V, I _D = 2.15A
Forward Transconductance (Notes 8 & 9)	g _{fs}	—	2.8	—	S	V _{DS} = 40V, I _D = 2.15A
Diode Forward Voltage (Note 8)	V _{SD}	—	0.880	0.950	V	I _S = 4.3A, V _{GS} = 0V
Reverse recovery time (Note 9)	t _{rr}	—	153	—	ns	I _S = 5.4A, V _{GS} = 0V,
Reverse recovery charge (Note 9)	Q _{rr}	—	1.1	—	μC	di/dt = 100A/μs
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	C _{iss}	—	169	—	pF	V _{DS} = 25V, V _{GS} = 0V f = 1MHz
Output Capacitance	C _{oss}	—	64.5	—	pF	
Reverse Transfer Capacitance	C _{rss}	—	23.3	—	pF	
Total Gate Charge	Q _g	—	6.6	—	nC	V _{DS} = 120V, V _{GS} = 10V I _D = 5.4A
Gate-Source Charge	Q _{gs}	—	1.0	—	nC	
Gate-Drain Charge	Q _{gd}	—	3.4	—	nC	
Turn-On Delay Time (Note 10)	t _{D(on)}	—	3.3	—	ns	V _{DD} = 75V, V _{GS} = 10V I _D = 5.4A, R _G ≅ 25Ω
Turn-On Rise Time (Note 10)	t _r	—	12.7	—	ns	
Turn-Off Delay Time (Note 10)	t _{D(off)}	—	17.1	—	ns	
Turn-Off Fall Time (Note 10)	t _f	—	13.3	—	ns	

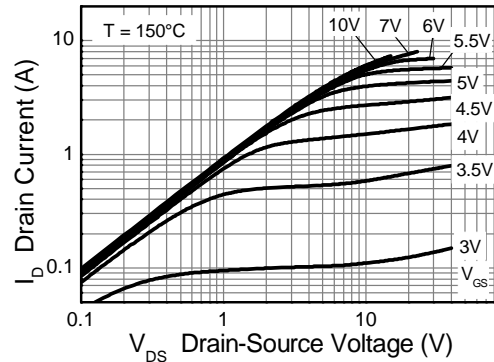
Notes: 8. Measured under pulsed conditions. Pulse width ≤ 300μs; duty cycle ≤ 2%
9. For design aid only, not subject to production testing.
10. Switching characteristics are independent of operating junction temperatures.

www.DataSheet4U.com

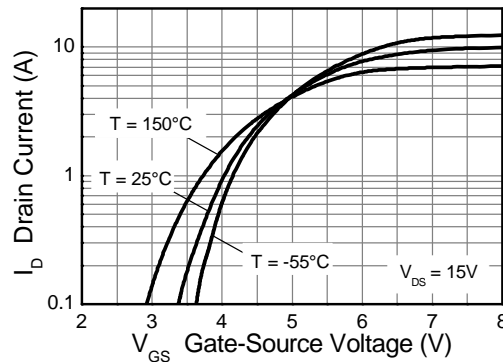
Typical Characteristics



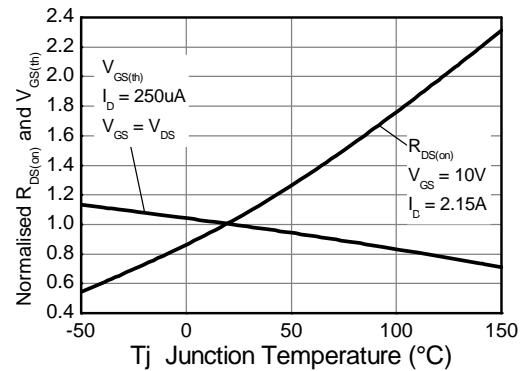
Output Characteristics



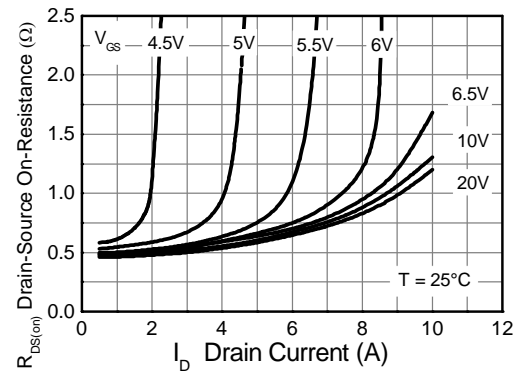
Output Characteristics



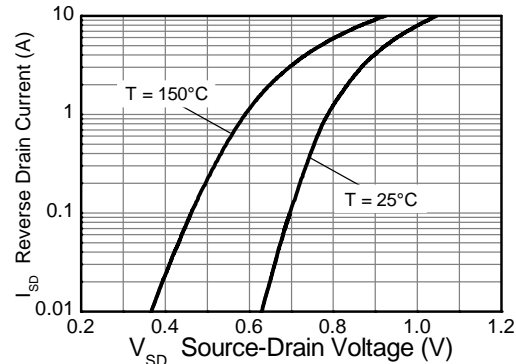
Typical Transfer Characteristics



Normalised Curves v Temperature



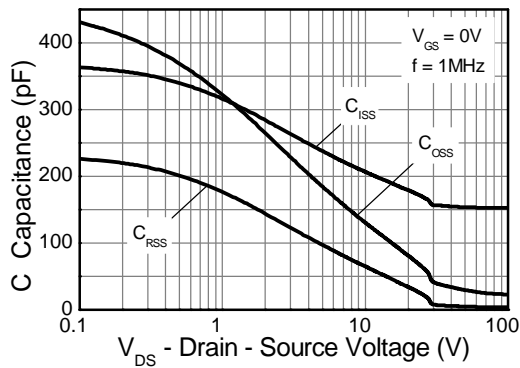
On-Resistance v Drain Current



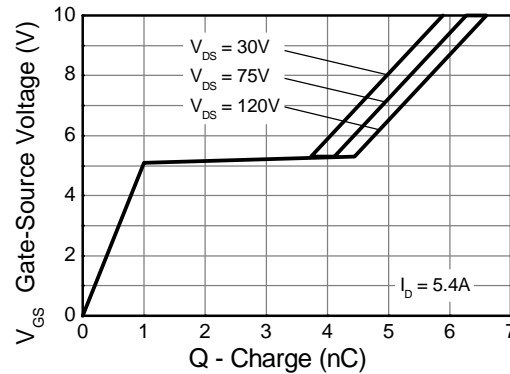
Source-Drain Diode Forward Voltage

www.DataSheet4U.com

Typical Characteristics - continued

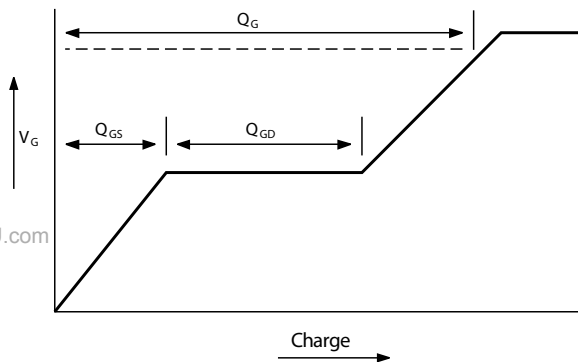


Capacitance v Drain-Source Voltage

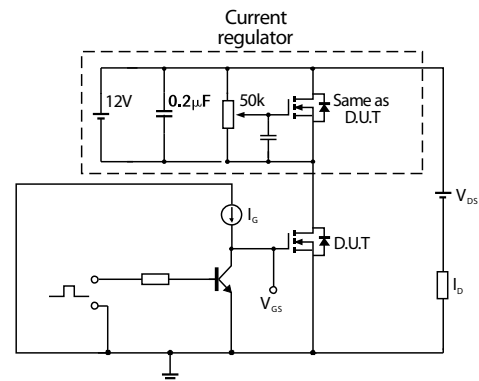


Gate-Source Voltage v Gate Charge

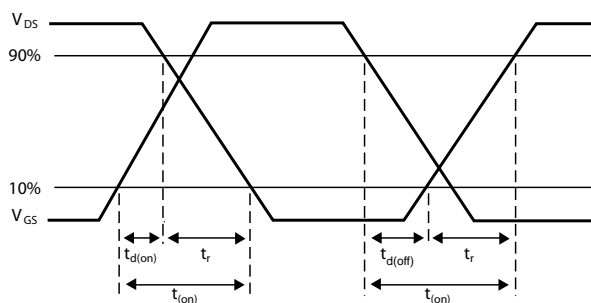
Test Circuits



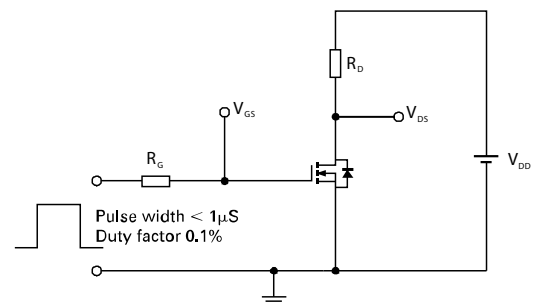
Basic gate charge waveform



Gate charge test circuit



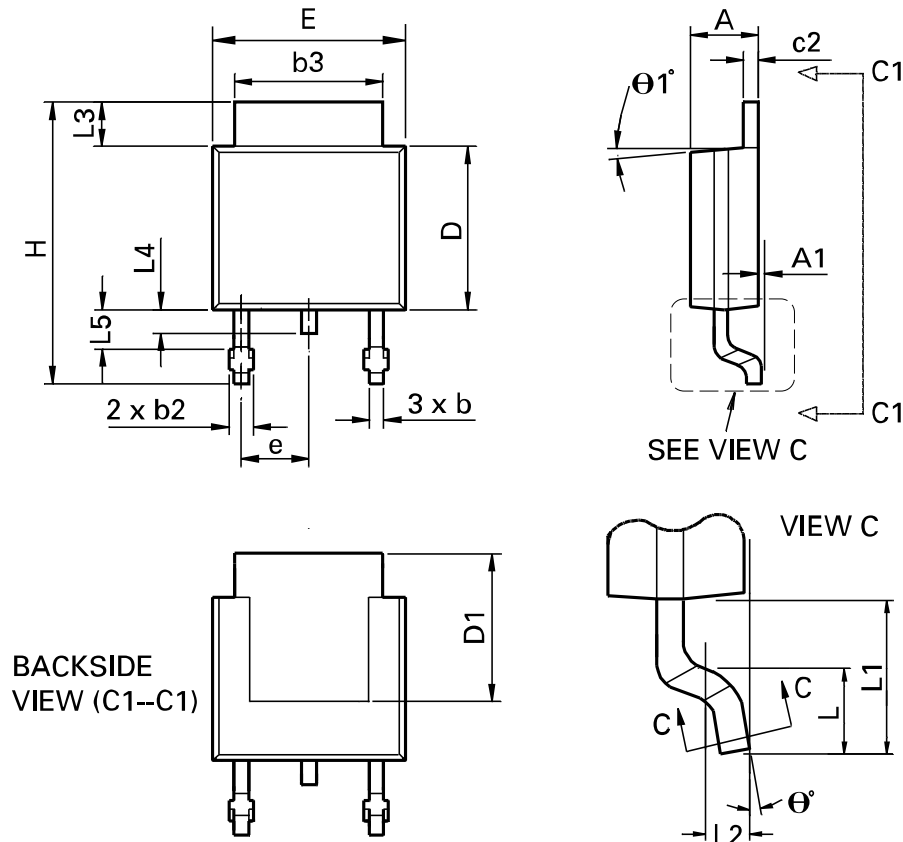
Switching time waveforms



Switching time test circuit

ZXMN15A27K

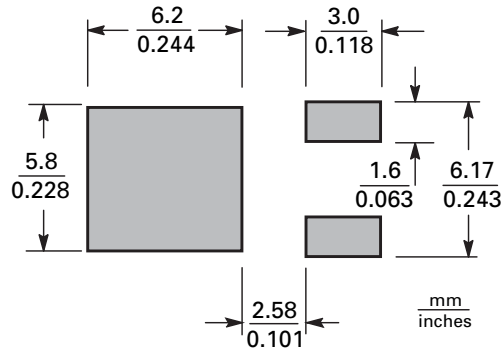
Package Outline Dimensions



www.DataSheet4U.com

DIM	Inches		Millimeters		DIM	Inches		Millimeters	
	Min	Max	Min	Max		Min	Max	Min	Max
A	0.086	0.094	2.18	2.39	e	0.090 BSC		2.29 BSC	
A1	-	0.005	-	0.127	H	0.370	0.410	9.40	10.41
b	0.020	0.035	0.508	0.89	L	0.055	0.070	1.40	1.78
b2	0.030	0.045	0.762	1.14	L1	0.108 REF		2.74 REF	
b3	0.205	0.215	5.21	5.46	L2	0.020 BSC		0.508 BSC	
c	0.018	0.024	0.457	0.61	L3	0.035	0.065	0.89	1.65
c2	0.018	0.023	0.457	0.584	L4	0.025	0.040	0.635	1.016
D	0.213	0.245	5.41	6.22	L5	0.045	0.060	1.14	1.52
D1	0.205	-	5.21	-	θ_1°	0°	10°	0°	10°
E	0.250	0.265	6.35	6.73	θ°	0°	15°	0°	15°
E1	0.170	-	4.32	-	-	-	-	-	-

Suggested Pad Layout



IMPORTANT NOTICE

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDING TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

LIFE SUPPORT

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

A. Life support devices or systems are devices or systems which:

1. are intended to implant into the body, or
2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.

B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2009, Diodes Incorporated

www.diodes.com